

SPECIFICATION FOR LCD MODULE MODULE NO: YB-YG7201280C12A-N-A0

Doc.Version:03

Customer Approval:

Accept

Reject

| YEEBO | NAME | SIGNATURE | DATE |
|----------|---------------------|-----------|------------|
| Prepare | Electronic Engineer | 张影彩 | 2020-09-14 |
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■ APPROVAL FOR SPECIFICATIONS ONLY

□ APPROVAL FOR SPECIFICATIONS AND SAMPLE

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DOCUMENT REVISION HISTORYed

| Version | DATE | DESCRIPTION | CHANGED BY |
|---------|------------|---|--------------|
| VA | 2020.8.05 | NEW design | Wangxin |
| 01 | 2020.09.09 | Update Limited Warranty & Dimensional Outline P2 & P22 | Wangxin |
| 02 | 2020.09.10 | Update AC Characteristics ······P8-P11 | Wangxin |
| 03 | 2020.09.14 | Update Backlight Characteristics ••••••P5 | Zhangyingcai |
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Module P/N: YB-YG7201280C12A-N-A0 Doc.Version:03

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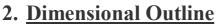
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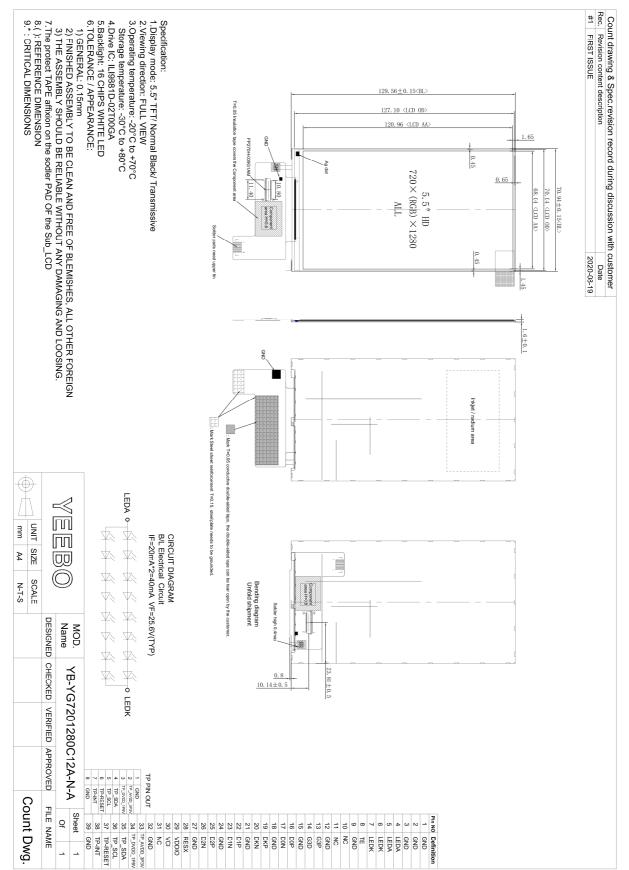
1. Features & Mechanical Specifications

| Item | Contents LCD | Unit |
|-----------------------|---|------|
| LCD Туре | TFT Transmissive Normal Black | |
| Viewing direction | ALL | |
| Backlight | White LED × 8pcs in Series and two chains in parallel | |
| Interface | MIPI DSI 4 Passageway | |
| Driver IC | ILI9881D-02T00GA | |
| Outline Dimension | 70.94 (W) x129.56(H) x1.70MAX(T) | mm |
| Glass area (W×H×T) | 70.04×127.10×0.4 | mm |
| Active area (W×H) | 68.04(W) x120.96(H) | mm |
| Number of Dots | 720 x RGB x 1280 | |
| Pixel pitch (W×H) | 31.5 x 94.5 | um |
| Operating Temperature | $-20 \sim +70$ | °C |
| Storage temperature | $-30\sim+80$ | °C |

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<u>4. Pin Description</u>

| PIN No. | SYMBOL | Function |
|---------|--------------|---|
| 1 | GND | Ground |
| 2 | GND | Ground |
| 3 | GND | Ground |
| 4 | LEDA | Backlight LED Anode |
| 5 | LEDA | Backlight LED Anode |
| 6 | LEDK | Backlight LED Cathode. |
| 7 | LEDK | Backlight LED Cathode. |
| 8 | TE | The FMARK signal is used when writing RAM data in synchronization with frame. Leave the pin open when not in use. |
| 9 | GND | Ground |
| 10 | NC | NC |
| 11 | NC | NC |
| 12 | NC | NC |
| 13 | D3P | Mipi data signal |
| 14 | D3N | Mipi data signal |
| 15 | GND | Ground |
| 16 | DOP | Mipi data signal |
| 17 | DON | Mipi data signal |
| 18 | GND | Ground |
| 19 | DKP | Mipi clock signal |
| 20 | DKN | Mipi clock signal |
| 21 | GND | Ground |
| 22 | D1P | Mipi data signal |
| 23 | D1N | Mipi data signal |
| 24 | GND | Ground |
| 25 | D2P | Mipi data signal |
| 26 | D2N | Mipi data signal |
| 27 | GND | Ground |
| 28 | RESX | Reset pin. Setting either pin low initializes the LSI. Must be reset after power is supplied |
| 29 | VDDIO | power supply 1.8V |
| 30 | VCI | power supply 2.8V |
| 31 | VCI | power supply 2.8V |
| 32 | GND | Ground |
| 33 | TP_AVDD_3P3V | TP_AVDD_3P3V |
| 34 | TP_DVDD_1P8V | TP_DVDD_1P8V |
| 35 | TP_SDA | TP_SDA |
| 36 | TP_SCL | TP_SCL |

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| 37 | TP-RESET | TP-RESET |
|----|----------|----------|
| 38 | TP-INT | TP-INT |
| 39 | GND | Ground |



5. Absolute Maximum Ratings

| Parameter | Symbol | Val | ue | Unit | Remarks | |
|------------------------------|--------------|-------|-------|------|---------|--|
| Parameter | Symbol | Min | Max | Unit | Remarks | |
| TFT Gate ON Voltage | VGH | 12 | 18 | V | Note 1 | |
| TFT Gate OFF Voltage | VGL | -12 | -7 | V | Note 2 | |
| TFT Common Electrode Voltage | VCom | -2 | 5 | V | Note 3 | |
| TFT Kick-Back Voltage | ΔV_p | 1.464 | 1.616 | V | | |

6. Electrical Characteristics

DC Characteristics

| Item | Symbol | Min. | Type. | Max. | Unit |
|----------------------|--------|------|-------|------|------|
| Logic Supply Voltage | VCC | 2.8 | - | 3.3 | V |
| I/O Supply Voltage | IOVCC | 1.65 | - | 3.0 | V |

7. Backlight Characteristics

White LED \times 8pcs in Series and two chains in parallel

 $(Ta = 25^{\circ}C)$

| PARAMETÉR | Sym | Min | Тур | Max | Unit | Test Condition | Note |
|-------------------------------|-----|-----|-------|-----|-------------------|----------------|------|
| Supply Current | IBL | - | 40 | - | mA | - | - |
| Voltage of the Backlight | VBL | - | 25.6 | - | V | - | - |
| Luminous Intensity for LCM | IV | 490 | 550 | - | Cd/m ² | | - |
| Uniformity for LCM | - | 70 | - | - | % | | - |
| LED Life Time | - | - | 50000 | - | Hr | | - |
| Color | | | | V | White | | |

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Color coordinates

Note: Test in White

| Item | | Symbol | Condition | Min. | Тур. | Max. |
|-----------------------------|---------------|--------|--|--------|--------|--------|
| | Del | х | | 0.5578 | 0.5878 | 0.6178 |
| | Red | У | | 0.3536 | 0.3836 | 0.4136 |
| | Green | х | $\theta = \phi = 0^{\circ}$ LED Backlight | 0.2443 | 0.2743 | 0.3043 |
| Chromaticity Coordinates | | У | | 0.6268 | 0.6568 | 0.6868 |
| (Transmissive) | Blue | X | | 0.1068 | 0.1368 | 0.1668 |
| | | У | | 0.0203 | 0.0503 | 0.0803 |
| | W 1 '4 | X | | 0.2481 | 0.2781 | 0.3081 |
| | White | У | | 0.3205 | 0.3505 | 0.3805 |

Measuring Condition 1. Measuring surrounding: dark room

2. Ambient temperature: 25±2°C

3. 30 min. Warm-up time.

8. Electro-Optical Characteristics

UsingCMO LCD+ Normal Polarizer+Corresponding Backlight, reference only (Note 1,Note 2)

| T. | | | | Speci | | | TI •4 | | |
|------------|-------|-------------------|------------------------------------|-------|------|-----|-------|---------|--|
| Item | | Symbol Conditions | | Min | Тур | Max | Unit | Note | |
| Transmitt | ance | T(%) | - | - | 3.5 | - | - | - | |
| Contrast 1 | Ratio | CR | θ=1± Normal Viewing Angle | 600 | 1000 | - | - | (1) (2) | |
| Response | time | TR+TF | | - | 25 | 35 | ms | (1) (3) | |
| | Llor | θx+ | CR≥10 | - | 80 | - | deg. | | |
| Viewing | Hor. | Өх- | | - | 80 | - | | (1) | |
| Angle | Vor | Өу+ | | - | 80 | - | | (1) | |
| | Ver. | Өу- | | - | 80 | - | | | |

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- 1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing are determined for the horizontal or 3, 9 o'dock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see FIGURE 2 shown in Appendix).
- Contrast measurements shall be made at viewing angle of Θ= 0令 and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state. (See FIGURE 2 shown in Appendix). Luminance measured with Polarizer. Luminance Contrast Ratio (CR) is defined mathematically

CR = Luminance when displaying a white raster Luminance when displaying a black raster

- 3. Transmittance is the value with Polarizer.
- 4. The color chromaticity coordinates specified in Table 4 shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the C/F without Polarizer. Measurement condition is C - light source & Halogen Lamp.
- 5. The electro-optical response time measurements shall be made as FIGURE 3 shown in Appendix by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Tr, and 90% to 10% is Td.

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<u>9. Instruction Description</u> Please refer to ILI9881D-02T00GA datasheet

10. AC Characteristics

High Speed Mode-Clock Channel Timing

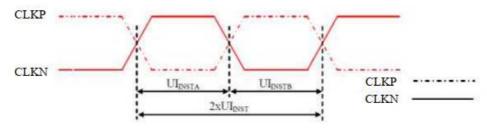


Figure 113: DSI Clock Channel Timing

Table 38: DSI Clock Channel Timing

| Signal | Symbol | Parameter | Min | Max | Unit |
|--------|---|-------------------------|--------|------|------|
| CLKP/N | 2xUI _{INST} | Double UI instantaneous | Note 2 | 25 | ns |
| CLKP/N | Ul _{INSTA} , Ul _{INSTB} (Note 1) | UI instantaneous Half | Note 2 | 12.5 | ns |

Notes:

1. UI = UIINSTA = UIINSTB

2. Define the minimum value of 24 UI per Pixel, see Table 39.

Table 39: Limited Clock Channel Speed

| Data type | Two Lanes speed | Three Lanes speed | Four Lanes speed |
|---|--------------------|----------------------|---------------------|
| Data Type = 00 1110 (0Eh), RGB 565, 16 UI per Pixel | 566 Mbps | 466 Mbps | 366 Mbps |
| Data Type = 01 1110 (1Eh), RGB 666, 18 UI per Pixel | 637 Mbps | 525 Mbps | 412 Mbps |
| Data Type = 10 1110 (2Eh), RGB 666 Loosely, 24 UI per Pixel | 850 Mbps | 700 Mbps | 550 Mbps |
| Data Type = 11 1110 (3Eh), RGB 888, 24 UI per Pixel | 850 Mbps | 700 Mbps | 550 Mbps |

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High Speed Mode-Date Clock Channel Timing

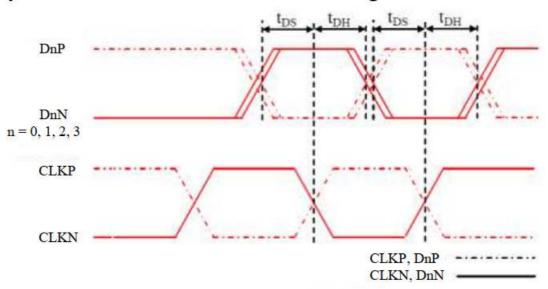


Figure 114: DSI Data to Clock Channel Timings

| Signal | Symbol | Parameter | Min | Max |
|-------------------|-----------------|--------------------------|---------|-----|
| D-D/N - 0100 | t _{DS} | Data to Clock Setup time | 0.15xUI | 1 |
| DnP/N , n=0,1,2,3 | t _{он} | Clock to Data Hold Time | 0.15xUI | 1 |

| Table 40: DSI Data to Clock Channel Timing | Table 40: | DSI Data to | Clock Channel | Timings |
|--|-----------|--------------------|----------------------|---------|
|--|-----------|--------------------|----------------------|---------|



Low Speed Mode Bus Turn Around

Lower Power Mode and its State Periods on the Bus Turnaround (BTA) from the MCU to the Display Module

(ILI9881D) are illustrated for reference purposes below.

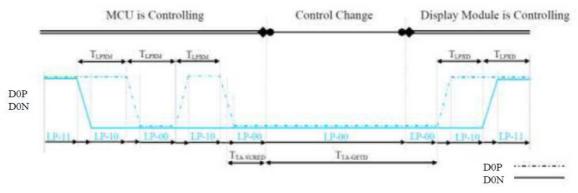


Figure 116: BTA from the MCU to the Display Module

Lower Power Mode and its State Periods on the Bus Turnaround (BTA) from the Display Module (ILI9881D) to the

MCU are illustrated for reference purposes below.

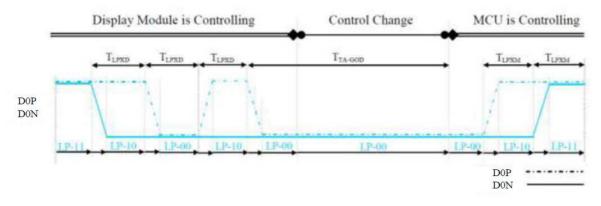


Figure 117: BTA from the Display Module to the MCU

| Signal | Symbol | Description | Min | Мах | Unit |
|--------|-----------------------|--|-------|---------------------|------|
| D0P/N | - | Length of LP-00, LP-01, LP-10 or LP-11 periods | 50 | 75 | |
| DUP/IN | TLPXM | MCU → Display Module (ILI9881D) | 50 | 75 | ns |
| DOD(N | - | Length of LP-00, LP-01, LP-10 or LP-11 periods | 50 | 75 | |
| D0P/N | LPXD | Display Module (ILI9881D) → MCU | 50 | 75 | ns |
| D0P/N | T _{TA-SURED} | Time-out before the Display Module (ILI9881D) starts driving | TLPXD | 2xT _{LPXD} | ns |

Table 42: Low Power State Period Timings - A

Table 43: Low Power State Period Timings - B

| Signal | Symbol | Description | Time | Unit |
|--------|----------------------|--|---------------------|------|
| D0P/N | T _{TA-GETD} | Time to drive LP-00 by Display Module (ILI9881D) | 5xT _{LPXD} | ns |
| D0P/N | T _{TA-GOD} | Time to drive LP-00 after turnaround request - MCU | 4xT _{LPXD} | ns |

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Data Lanes from Low Power Mode to High Speed Mode

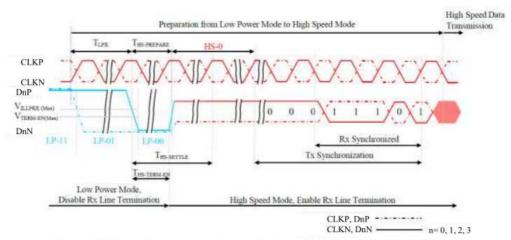


Figure 118: Data Lanes - Low Power Mode to High Speed Mode Timings

| Signal | Symbol | Description | Min | Max | Unit |
|--------------------|-------------------------|---|----------|---------|------|
| DnP/N, n = 0,1,2,3 | TLPX | Length of any Low Power State Period | 50 | - | ns |
| DnP/N, n = 0,1,2,3 | T _{HS-PREPARE} | Time to drive LP-00 to prepare for HS Transmission | 40+4xUI | 85+6xUI | ns |
| DnP/N, n = 0,1,2,3 | T _{HS-TERM-EN} | Time to enable Data Lane Receiver line termination measured from when Dn crosses VILMAX | <u>.</u> | 35+4xUI | ns |

| Table 44: Data | Lanes - Low | Power Mode | to High Speed | Mode Timings |
|----------------|-------------|------------|---------------|--------------|
|----------------|-------------|------------|---------------|--------------|

Data Lanes from Low Power Mode to High Speed Mode

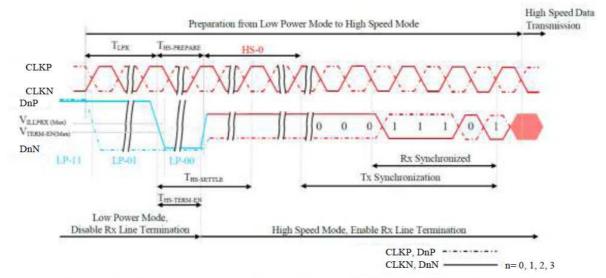


Figure 118: Data Lanes - Low Power Mode to High Speed Mode Timings

| Symbol | Description | Min | Мах | Unit |
|-------------------------|---|---|---|---|
| T _{LPX} | Length of any Low Power State Period | 50 | - | ns |
| T _{HS-PREPARE} | Time to drive LP-00 to prepare for HS Transmission | 40+4xUI | 85+6xUI | ns |
| T _{HS-TERM-EN} | Time to enable Data Lane Receiver line termination measured from when Dn crosses VII MAX | - | 35+4xUI | ns |
| | T _{LPX} T _{HS-PREPARE} | T _{LPX} Length of any Low Power State Period T _{HS-PREPARE} Time to drive LP-00 to prepare for HS Transmission _ Time to enable Data Lane Receiver line termination | T _{LPX} Length of any Low Power State Period 50 T _{HS-PREPARE} Time to drive LP-00 to prepare for HS Transmission 40+4xUI T _{HS-TEPMEN} Time to enable Data Lane Receiver line termination 40+4xUI | TLPX Length of any Low Power State Period 50 - T _{HS-PREPARE} Time to drive LP-00 to prepare for HS Transmission 40+4xUI 85+6xUI T _{HS-TERMEN} Time to enable Data Lane Receiver line termination - 35+4xUI |

| Table 44: Data Lanes - Lo | ow Power Mode to High | N Speed Mode Timinas |
|---------------------------|-----------------------|----------------------|
| | | |

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DSI Clock Burst High Speed Mode to/from Low Power Mode

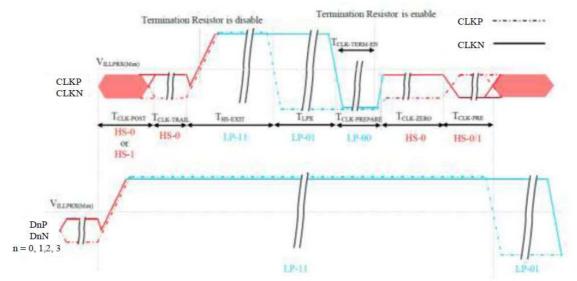


Figure 120: Clock Lanes - High Speed Mode to/from Low Power Mode Timings

| Signal | Symbol | Description | Min | Max | Unit |
|--------|---|---|----------|-----|------|
| CLKP/N | T _{CLK-POST} | Time that the MCU shall continue sending HS clock after the last associated Data Lanes has transitioned to LP mode | 60+52xUI | - | ns |
| CLKP/N | T _{CLK-TRAIL} | Time to drive HS differential state after last payload clock bit of a HS transmission burst | 60 | - | ns |
| CLKP/N | T _{HS-EXIT} | Time to drive LP-11 after HS burst | 100 | - | ns |
| CLKP/N | T _{CLK-PREPARE} | Time to drive LP-00 to prepare for HS transmission | 38 | 95 | ns |
| CLKP/N | T _{CLK-TERM-EN} | Time-out at Clock Lane to enable HS termination | - | 38 | ns |
| CLKP/N | T _{CLK-PREPARE} + T _{CLK-ZERO} | Minimum lead HS-0 drive period before starting Clock | 300 | - | ns |
| CLKP/N | T _{CLK-PRE} | Time that the HS clock shall be driven prior to any associated Data Lane beginning the transition from LP to HS mode | 8xUI | - | ns |

| Table 46: Clock Lanes | - High Speed Mode t | o/from Low Power | Mode Timinas |
|------------------------|---------------------|------------------|---------------|
| Tuble 40. Clock Lulies | - mgn opeeu moue i | | mode rinnings |

Reset Timing

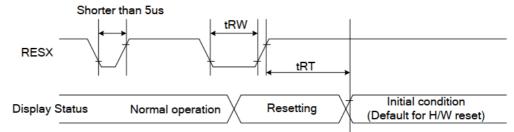


Figure 121: Reset Timing

| Table 47 | ': Re | set T | imina |
|----------|-------|-------|-------|
|----------|-------|-------|-------|

| Signal | Symbol | Parameter | Min | Мах | Unit |
|--------|--------|----------------------|--------------|------------------|------|
| | tRW | Reset pulse duration | 10 | | uS |
| RESX | (DT | Desetered | 5 (note 1.5) | mS | |
| | tRT | Reset cancel | | 120 (note 1,6,7) | mS |

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Notes:

- The reset cancel also includes required time for loading ID bytes, VCOM setting and other settings from EEPROM to registers. This loading is done every time when there is H/W reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the Table 48.

| RESX Pulse | Action | | |
|----------------------|----------------|--|--|
| Shorter than 5us | Reset Rejected | | |
| Longer than 10us | Reset | | |
| Between 5us and 10us | Reset starts | | |

Table 48: Reset Descript

- 3. During the Resetting period, the display will be blanked (The display enters the blanking sequence, which maximum time is 120 ms, when Reset Starts in the Sleep Out mode. The display remains the blank state in the Sleep In mode.) and then return to Default condition for Hardware Reset.
- 4. Spike Rejection can also be applied during a valid reset pulse, as shown below:

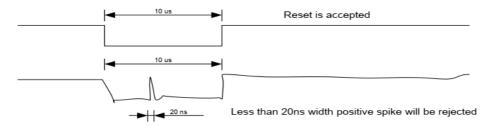


Figure 122: Positive Noise Pulse during Reset Low

- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- 7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

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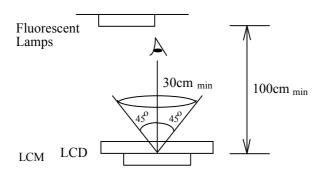
<u>11.Quality Specifications</u>

All The raw material are Rohs complicant.

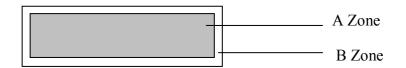
11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area

B Zone: outside viewing area

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11.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

| Classify | | Item | Note | AQL |
|----------|---------------|------------------------------|------|------|
| Major | Display state | Short or open circuit | | 0.65 |
| | | LC leakage | | |
| | | Flickering | 1 | |
| | | No display | | |
| | | Wrong viewing direction | | |
| | | Contrast defect (dim, ghost) | 2 | |
| | | Back-light | 1,8 | |
| | Non-display | Flat cable or pin reverse | 10 | |
| | | Wrong or missing component | 11 | |
| Minor | Display state | Background color deviation | 2 | 1.0 |
| | | Black spot and dust | 3 | |
| | | Line defect, Scratch | 4 | |
| | | Rainbow | 5 | |
| | | Chip | 6 | |
| | | Pin hole | 7 | |
| | Polarizer | Protruded | 12 | |
| | | Bubble and foreign material | 3 | |
| | Soldering | Poor connection | 9 | |
| | Wire | Poor connection | 10 | |
| | TAB | Position, Bonding strength | 13 | |

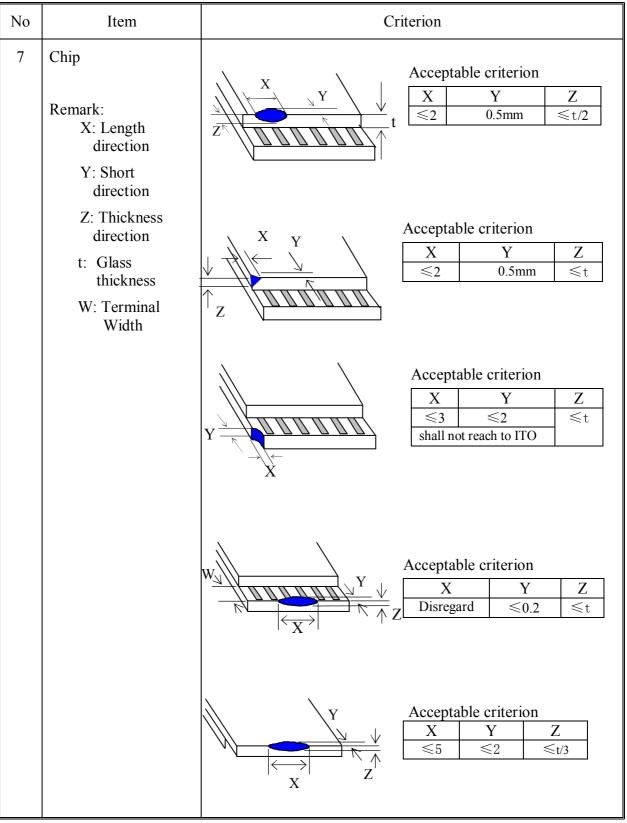
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Note on defect classification

| No. | Item | | | Criterion | |
|-----|--|--|----------------------------------|---|--|
| 1 | Short or open circuit | Not allow | | | |
| | LC leakage | | | | |
| | Flickering | | | | |
| | No display | | | | |
| | Wrong viewing direction | | | | |
| | Wrong Back-light | | | | |
| 2 | Contrast defect | | Refer | to approval san | nple |
| | Background color deviation | | | | |
| 3 | Point defect, Black spot, dust (including Polarizer) $\phi = (X+Y)/2$ Line defect, | $ \begin{array}{c} $ | | Point Size <u> </u> | Acceptable Qty. Disregard 2(距离大于5mm) 1 0 nm |
| | Scratch | | L 3.0≥L 2.0≥L 1.0≥L | W 0.015≥W ∠ 0.03≥W ∠ 0.05≥W | Disregard 2 1 |
| | | 0.05 <w applied="" as="" defect<br="" point="">Unit: mm</w> | | | |
| 5 | Rainbow | Not more than two color changes across the viewing area. | | | |
| 6 | All black, grey scale screen: dark spots, dark blocks, Mura(uneven display), etc | Cover the test with ND8 filter. If it is not visible, it will be judged as OK. | | | |

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| No. | Item | Criterion | | |
|-----|---|---|--|--|
| 8 | Segment pattern W = Segment width $\phi = (X+Y)/2$ | (1) Pin hole $\phi < 0.10$ mm is acceptable. X $\rightarrow 1/4$ | | |
| | | YXPoint SizeAcceptable QtyY \downarrow < | | |
| 9 | Back-light | (1) The color of backlight should correspond its specification.(2) Not allow flickering | | |
| 10 | Soldering | (2) Not allow mckering (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. | | |
| 11 | Wire | 50% lead | | |
| 11 | WIIC | (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable. | | |
| 12 | РСВ | (1) Not allow screw rust or damage. (2) Not allow missing or wrong putting of component. | | |

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| | YEEBO GROUP | | | | | |
|----|-----------------------------------|--|--|--|--|--|
| No | Item | Criterion | | | | |
| 13 | Protruded W: Terminal Width | $W_{\underline{y}}$ $W_{\underline{y}$ $W_{\underline{y}}$ $W_{\underline{y}}$ $W_{\underline{y}}$ $W_{\underline{y}}$ $W_{$ | | | | |
| 14 | TAB | 1. Position H H | | | | |
| | | $F = F/FPC \text{ bonding width} \geq 650 \text{gf/cm ,(speed rate: 1mm/min)}$ Spcs per SOA (shipment) | | | | |
| | | | | | | |
| 15 | Total no. of acceptable Defect | A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product. | | | | |

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11.3 Reliability of LCM

Reliability test condition:

| Item | Condition | Time (hrs) | Assessment |
|----------------------|---|------------|------------------|
| High temp. Storage | 80°C | 120H | |
| High temp. Operating | 70°C | 120H | |
| Low temp. Storage | -30°C | 120H | No abnormalities |
| Low temp. Operating | -20°C | 120H | in functions |
| Humidity | 60°C/ 90%RH | 240H | and appearance |
| Temp. Cycle | $-20^{\circ}C \leftarrow 25^{\circ}C \rightarrow 70^{\circ}C$ | 10cycles | |
| | (60 min \leftarrow 5 min \rightarrow 60min) | | |

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below 60% RH), and in the area not exposed to direct sun light.

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11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting YEEBO.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or

twisting. Elastomer contacts are very delicate and missing pixels could result from slight

dislocation of any of the elements.

6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and

lose contact, resulting in missing pixels and also cause rainbow on the display.

7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

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Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: $280^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display
- 4. **Rfs**sponse time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate

bubblEsr long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty:

YEEBO LCDs and modules are not consumer products, but may be incorporated by YEEBO's customers into consumer products or components thereof, YEEBO does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of YEEBO is limited to repair or replacement on the terms set forth below. YEEBO will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between YEEBO and the customer, YEEBO will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with YEEBO general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.